AMENDMENTS TO THE CLAIMS

Amendments to the Claims

This listing of claims will replace all prior listings in this application.

Listing of Claims:

- 1. (Currently amended) A method of fabricating a thin layer, in which a weak buried region is created by implanting a chemical species in a substrate in order to thereafter initiate a fracture of saidthe_substrate along saidthe_weak region to detach saidthe thin layer therefrom, saidthe method comprising:
- a) implanting a first chemical species in the substrate at a first depth to form the weak buried region:
- b) implanting at least one second chemical species, in the substrate at a second depth different from saidthe first depth and at an atomic concentration higher than the atomic concentration of saidthe first chemical species,

wherein said<u>the</u> at least one second chemical species is less effective than said<u>the first chemical species at weakening the substrate <u>and resides outside of the</u> weak buried region, and</u>

wherein steps a) and b) can be executed in either order;

- diffusing at least a portion of said<u>the</u> at least one second chemical species from said<u>the</u> second depth to the vicinity of said-first-depth into the weak buried region, and
 - d) initiating saidthe fracture along saidthe first depth.
- (Currently amended) A fabrication method according to claim 1, wherein saidthe second depth is greater than saidthe first depth.
- (Currently amended) A fabrication method according to claim 1, wherein said<u>the</u> second depth is less than said<u>the</u> first depth.
- (Currently amended) A fabrication method according to claim 2, wherein implanting at least one second chemical species is carried out before implanting said<u>the</u>

first chemical species.

- (Currently amended) A fabrication method according to claim 1, wherein said diffusing at least a portion of said<u>the</u> second chemical species further comprises applying a heat treatment.
- (Currently amended) A fabrication method according to according to claim
 wherein initiating saidthe fracture further comprises applying a heat treatment.
- (Previously presented) A fabrication method according to according to claimwherein steps c) and d) are carried out simultaneously.
- 8. (Currently amended) A fabrication method according to according to claim 5, wherein applying said<u>the</u> heat treatment comprises carrying out said<u>the</u> heat treatment within a first thermal budget, wherein the first thermal budget is lower than a second thermal budget that would be necessary to initiate said<u>the</u> fracture in the absence of steps b) and c).
- 9. (Currently amended) A fabrication method according to claim 5, wherein applying saidthe heat treatment comprises carrying out saidthe heat treatment within a first thermal budget by implanting an additional amount of saidthe at least one second chemical species, such that saidthe first thermal budget is lower than a second thermal budget required in the absence of saidthe additional amount of saidthe at least one second chemical species.
- (Currently amended) A fabrication method according to claim 5, wherein applying saidthe heat treatment comprises one or more of heating in a furnace, heating, or laser heating.
- 11. (Currently amended) A fabrication method according to wherein initiating saidthe fracture includes applying mechanical stresses.
- (Currently amended) A fabrication method according to claim 11, wherein applying saidthe mechanical stresses comprises one or more of applying a jet of fluid,

inserting a blade into the implanted region, applying traction, applying shear or bending stresses to the substrate, or applying acoustic waves.

- 13. (Currently amended) A fabrication method according to claim 1, wherein, before or during initiating saidthe fracture, a thickener is applied to saidthe substrate to serve as a support for saidthe thin layer after saidthe fracture of saidthe thin layer from saidthe substrate.
- 14. (Currently amended) A fabrication method according to claim 1, wherein, before or during initiating said<u>the</u> fracture, a handle support is applied to said<u>the</u> substrate, after which said<u>the</u> thin layer is transferred onto a final support.
- (Currently amended) A fabrication method according to claim 1 wherein saidthe first chemical species comprises hydrogen ions.
- 16. (Currently amended) A fabrication method according to claim 1, wherein saidthe at least one second chemical species comprises at least one rare gas.
- 17. (Previously presented) A thin layer fabricated by a method according to claim 1
- (Currently amended) A thin layer according to claim 17, further comprising a support underlying saidthe thin layer.
- 19. (Currently amended) A fabrication method according to claim 3, wherein implanting at least one second chemical species is carried out before implanting said<u>the</u> first chemical species.
- (Previously presented) A fabrication method according to according to claim 6, wherein steps c) and d) are carried out simultaneously.
- 21. (Currently amended) A fabrication method according to according to claim 6, wherein applying saidthe heat treatment comprises carrying out saidthe heat treatment within a first thermal budget, wherein saidthe first thermal budget is lower

than a second thermal budget that would be necessary to initiate saidthe fracture in the absence of steps b) and c).

- 22. (Currently amended) A fabrication method according to according to claim 7, wherein applying saidthe heat treatment comprises carrying out saidthe heat treatment within a first thermal budget, wherein saidthe first thermal budget is lower than a second thermal budget that would be necessary to initiate saidthe fracture in the absence of steps b) and c).
- 23. (Currently amended) A method of fabricating a thin layer, in which a weak buried region is created by implanting a chemical species in a substrate in order to thereafter initiate a fracture of said<u>the</u> substrate along said<u>the</u> weak region to detach said<u>the-the</u> thin layer therefrom, said<u>the-method</u> comprising:
- a) implanting a first chemical species in the substrate at a first depth to form the weak buried region;
- b) implanting at least one second chemical species, in the substrate at a second depth different from eaidthe first depth and at a concentration higher than the concentration of saidthe first chemical species,

wherein said<u>the</u> at least one second chemical species is less effective than said<u>the first chemical species at weakening the substrate <u>and resides outside of the</u> weak buried region, and</u>

wherein steps a) and b) can be executed in either order;

- diffusing at least a portion of saidthe at least one-second chemical species from saidthe second depth to the vicinity of said first depth into the weak buried region, and
 - d) initiating saidthe fracture along saidthe first depth,

wherein the method is carried out by either applying a heat treatment for less time and at a lower temperature then that necessary in the absence of step b), or by implanting an additional amount of saidthe at least one second chemical species to avoid exceeding a predetermined time/temperature regime.